

# STS4DNFS30

# N-channel - 30V - 0.044Ω - 4.5A SO-8 STripFET™ Power MOSFET plus schottky rectifier

### **General features**

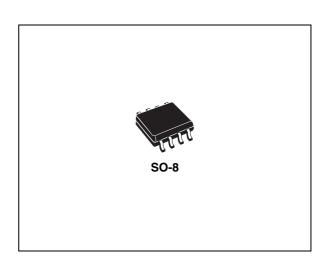
Туре	V <sub>DSS</sub> R <sub>DS(on)</sub> 30V <0.055Ω		I <sub>D</sub>
STS4DNFS30			4.5A
Schottky	I <sub>F(AV)</sub>	V <sub>RRM</sub>	V <sub>F(MAX)</sub>

### **Description**

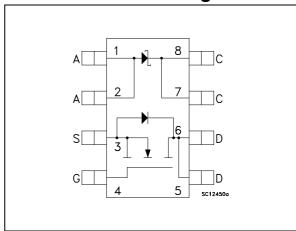
This product associates the latest low voltage STripFET™ in n-channel version to a low drop Schottky diode. Such configuration is extremely versatile in implementing a large variety of DC-DC converters for printers, portable equipment.

### **Applications**

Switching application



### Internal schematic diagram



### **Order codes**

Part number	Marking	Package	Packaging
STS4DNFS30	S4DNFS30	SO-8	Tape & reel

Contents STS4DNFS30

# **Contents**

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves)	6
3	Test circuits	8
4	Package mechanical data	9
5	Revision history	11

STS4DNFS30 Electrical ratings

# 1 Electrical ratings

Table 1. Mosfet absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	30	V
V <sub>GS</sub>	Gate- source voltage	± 20	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25°C	4.5	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100°C	3.2	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	13	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	2	W

<sup>1.</sup> Pulse width limited by safe operating area

Table 2. Schottky absolute maximum ratings

Symbol	Parameter		Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage		30	V
I <sub>F(RMS)</sub>	RMS forward current		10	Α
I <sub>F(AV)</sub>	Average forward current	T <sub>L</sub> =125°C δ=0.5	4	Α
I <sub>FSM</sub>	Surge non repetitive forward current	tp=10ms Sinusoidal	75	Α
I <sub>RRM</sub>	Repetitive peak reverse current	tp=2µs F=1kHz	1	Α
I <sub>RSM</sub>	Non repetitive peak reverse current	tp=100µs	1	Α
dv/dt	Critical rate of rise of reverse voltage		10000	v/µs

Table 3. Thermal data

Symbol	Parameter	Value	Unit
Rthj-amb	Thermal resistance junction-amb Mosfet (1)	62.5	°C/W
T <sub>stg</sub>	Storage temperature range Max	-55 to 150	°C
T <sub>j</sub>	Junction temperature	-55 to 150	°C

<sup>1.</sup> Mounted on FR-4 board (steady state)

Electrical characteristics STS4DNFS30

# 2 Electrical characteristics

(Tcase =25°C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250\mu A, V_{GS} = 0$	30			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating $V_{DS}$ = Max rating, $T_{C}$ =125°C			1 10	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20V			± 100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	1			V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 10V$ , $I_D = 2A$ $V_{GS} = 5V$ , $I_D = 2A$		0.044	0.055 0.085	Ω Ω

Table 5. Static

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	$T_j = 25^{\circ}C$ $T_j = 100^{\circ}C$	$V_R = V_{RRM}$		6	200 15	μA mA
V <sub>F</sub> <sup>(1)</sup>	Zero gate voltage	I <sub>j</sub> = 125°C	I <sub>F</sub> = 2A		0.325	0.45 0.375	V V
<b>v</b> F`'	drain current ( $V_{GS} = 0$ )	$T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	I <sub>F</sub> = 4A		0.43	0.53 0.51	V V

<sup>1.</sup> Pulse test: tp=380 $\mu$ s,  $\delta$  < 2%. To evaluate the conduction losses use the following equation:

$$P = 0.24 \times I_{F(AV)} + 0.068I_{F^2}(RMS)$$

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 <sub>fs</sub>	Forward transconductance	V <sub>DS</sub> =10V, I <sub>D</sub> =2A		5		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz, V}_{GS} = 0$		330 115 28		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 15V$ , $I_D = 4.5A$ , $V_{GS} = 5V$ (see Figure 13)		4.7 1.2 2.1		nC nC nC

Table 7. Switching times

	<u> </u>					
Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
t <sub>d(on)</sub>	Turn-on delay time Rise time	$V_{DD}$ = 15V, $I_D$ = 2A, $R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 5V (see Figure 12)		9 17		ns ns
t <sub>d(off)</sub>	Turn-off delay time Fall time	$V_{DD}$ = 15V, $I_D$ = 2A, $R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 5V (see <i>Figure 12</i> )		15 6		ns ns

Table 8. Source drain diode

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current				4.5	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				13	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 4.5A, V_{GS} = 0$			1.2	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 4.5A$ , di/dt = 100A/ $\mu$ s		22		ns
$Q_{rr}$	Reverse recovery charge	V <sub>DD</sub> = 15V, T <sub>j</sub> = 150°C		14.3		nC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 17)		1.3		Α

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5 %

Electrical characteristics STS4DNFS30

### 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

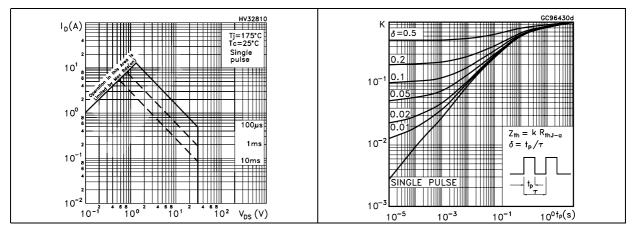


Figure 3. Output characterisics

Figure 4. Transfer characteristics

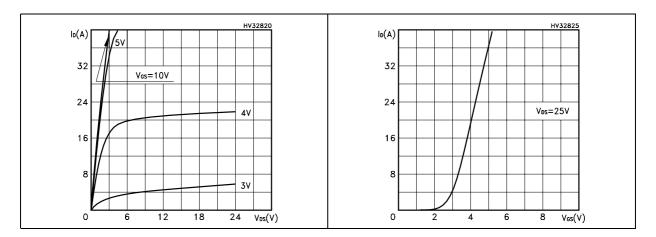


Figure 5. Source-drain diode forward characteristics

Figure 6. Static drain-source on resistance

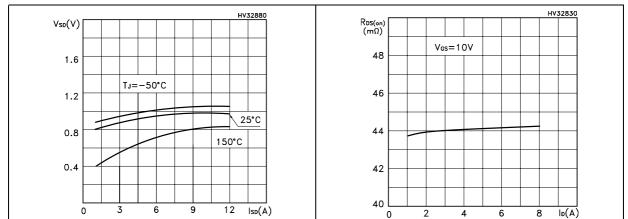


Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

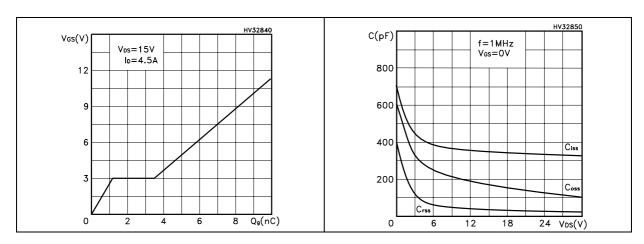


Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs vs temperature temperature

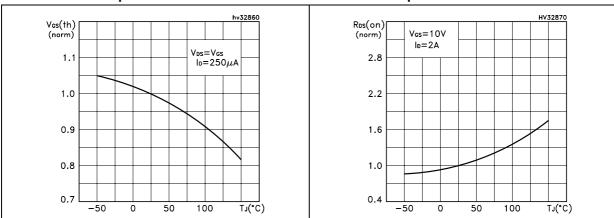
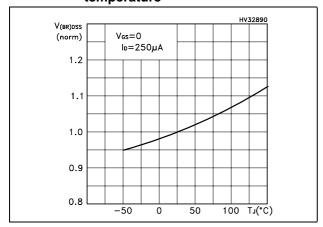


Figure 11. Normalized BV<sub>DSS</sub> voltage vs temperature



**577** 

Test circuits STS4DNFS30

### 3 Test circuits

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

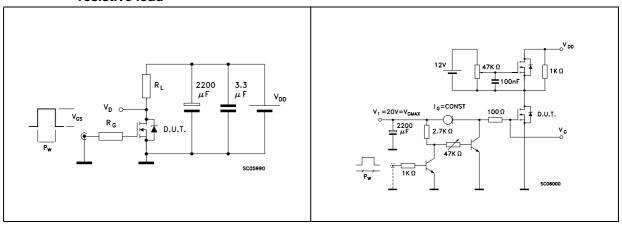


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped inductive load test circuit

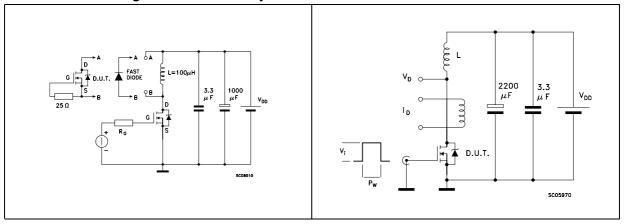
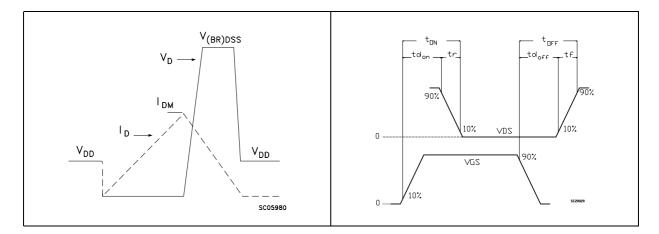


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform



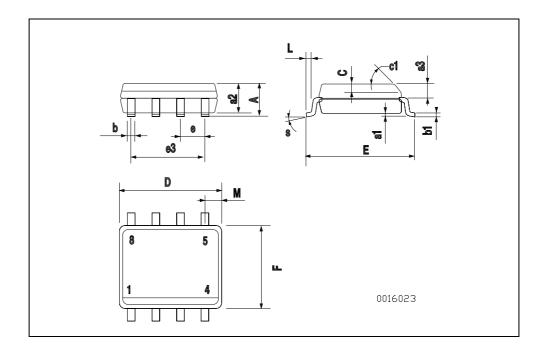
**57** 

# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

### **SO-8 MECHANICAL DATA**

DIM	mm.		inch			
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45 (	(typ.)		•
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S		•	8 (n	nax.)	•	•



STS4DNFS30 Revision history

# 5 Revision history

Table 9. Revision history

Date	Revision	Changes
19-Jul-2005	1	First release

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com